

♦ STRUCTURE Silicon Monolithic Integrated Circuit
 ♦ PRODUCT I²C BUS 4Kbit (512 × 8bit) EEPROM

♦ PART NUMBER BU9847GUL-W

PART NUMBER	PACKAGE
BU9847GUL-W	VCSP50L1

♦ FEATURES Two wire serial interface

Wide operating voltage range (1.7V~5.5V) Endurance : 1,000,000 erase/write cycles

♦ ABSOLUTE MAXIMUM RATING (Ta=25°C)

Parameter	Symbol	Rating		Unit
Supply Voltage	Vcc	−0.3 ~ 6.5		V
Power Dissipation	Pd	220 (BU9847GUL-W)	*1	mW
Storage Temperature	Tstg	-65 ~ 125		°C
Operating Temperature	Topr	-40∼85		°C
Terminal Voltage	_	-0.3∼Vcc+1.0	*2	V

^{*1} Degradation is done at 2.2mW/°C(*1) for operation above 25°C.

♦ RECOMMENDED OPERATING CONDITION

Parameter	Symbol	Rating	Unit
Supply Voltage	Vcc	1.7 ~ 5.5	٧
Input Voltage	VIN	0∼Vcc	V

^{*2} The max value of terminal voltage is not over 6.5V.



♦ MEMORY CELL CHARACTERISTICS (Ta=25°C, Vcc=1.7~5.5V)

Parameter			Unit		
Parameter		Min.	Тур.	Max.	Unit
Write/Erase Cycle	*1	1,000,000	-	-	Cycles
Data Retention	*1	40	-	-	Years

OInitial Data FFh in all address.

*1 Not 100% TESTED

♦ DC OPERATING CHARACTERISTICS

(Unless otherwise specified Ta=-40~85°C, Vcc=1.7~5.5V)

(Offices otherwise specified Ta 40 - 00 C, VCC-1.7 - 0.5V)						
Specification Un		I I in	T. 10 Fi			
Symbol	Min.	Тур.	Max.	Unit	Test Condition	
VIH1	0.7Vcc	-	Vcc+1.0	٧	2.5V≦Vcc≦5.5V	
VIL1	-0.3	-	0.3Vcc	٧	2.5V≦Vcc≦5.5V	
VIH2	0.8Vcc	ı	Vcc+1.0	٧	1.8V≦Vcc<2.5V	
VIL2	-0.3	1	0.2Vcc	٧	1.8V≦Vcc<2.5V	
VIH3	0.9Vcc	-	Vcc+1.0	٧	1.7V≦Vcc<1.8V	
VIL3	-0.3	-	0.1Vcc	٧	1.7V≦Vcc<1.8V	
VOL1	-	-	0.4	٧	IOL=3.0mA, 2.5V≦Vcc≦5.5V(SDA)	
VOL2	-	ı	0.2	٧	IOL=0.7mA, 1.7V≦Vcc<2.5V(SDA)	
ILI	-1	ı	1	μА	VIN=0V~Vcc	
ILO	-1	ı	1	μА	VOUT=0V~Vcc(SDA)	
ICC1			2.0	A	Vcc=5.5V,fSCL=400kHz, tWR=5ms	
1001			2.0	ΞĬ	Byte Write,Page Write	
ICC2	_		0.5	mΛ	Vcc=5.5V,fSCL=400kHz	
1002	1		0.5	шА	Random Read,Current Read,Sequential Read	
ISB	_	_	20	2.0	Δ	Vcc=5.5V,SDA,SCL=Vcc
100			2.0	μА	A0,A1,A2=GND,WP=GND	
	VIL1 VIH2 VIL2 VIH3 VIL3 VOL1 VOL2	Symbol Min. VIH1 0.7Vec VIL1 -0.3 VIH2 0.8Vec VIL2 -0.3 VIH3 0.9Vec VIL3 -0.3 VOL1 - VOL2 - ILI -1 ILO -1 ICC1 - ICC2 -	Symbol Min. Typ. VIH1 0.7Vcc — VIL1 -0.3 — VIH2 0.8Vcc — VIH3 0.9Vcc — VIL3 -0.3 — VOL1 — — VOL2 — — ILI -1 — ICO1 — — ICC1 — —	Nymbol Min. Typ. Max. VIH1 0.7Vcc — Vcc+1.0 VIL1 -0.3 — 0.3Vcc VIH2 0.8Vcc — Vcc+1.0 VIH3 0.9Vcc — Vcc+1.0 VIL3 -0.3 — 0.1Vcc VOL1 — — 0.4 — 0.2 ILI -1 — 1 ILO -1 — 1 ICC1 — — 2.0 ICC2 — — 0.5 ISB — — 2.0	Symbol Min. Typ. Max. VIH1 0.7Vcc — Vcc+1.0 V VIL1 -0.3 — 0.3Vcc V VIH2 0.8Vcc — Vcc+1.0 V VIL3 -0.3 — 0.2Vcc V VIL3 -0.3 — 0.1Vcc V VOL1 — — 0.4 V VOL2 — — 0.2 V ILI -1 — 1 μA ICC1 — — 2.0 mA ICC2 — — 0.5 mA	

OThis product is not designed for protection against radioactive rays.

♦ AC OPERATING CHARACTERISTICS

(Unless otherwise specified Ta=-40~85°C, Vcc=1.7~5.5V)

The second will be specific	Symbol	FAST-MODE 1.7V≦Vcc≦5.5V			Unit
Parameter		1.7V=			
		Min.	Тур.	Max.	
Clock Frequency	fSCL	-	-	400	kHz
Data Clock High Period	tHIGH	0.6	-	-	μs
Data Clock Low Period	tLOW	1.2	-	ı	μs
SDA and SCL Rise Time *1	tR	-	-	0.3	μs
SDA and SCL Fall Time *1	tF	-	-	0.3	μs
Start Condition Hold Time	tHD:STA	0.6	-	-	μs
Start Condition Setup Time	tSU:STA	0.6	-	-	μs
Input Data Hold Time	tHD:DAT	0	-	-	ns
Input Data Setup Time	tSU:DAT	100	-	-	ns
Output Data Delay Time	tPD	0.1	-	0.9	μs
Output Data Hold Time	tDH	0.1	-	-	μs
Stop Condition Setup Time	tSU:STO	0.6	-	ı	μs
Bus Free Time	tBUF	1.2	-	-	μs
Write Cycle Time	tWR	-	-	5	ms
Noise Spike Width (SDA and SCL)	tI	-	-	0.1	μs
WP Hold Time	tHD:WP	0	-	-	ns
WP Setup Time	tSU:WP	0.1	-	-	μs
WP High Period	tHIGH:WP	1.0	_	-	μs

*1 Not 100% TESTED

♦ BLOCK DIAGRAM

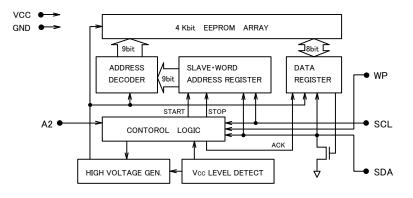
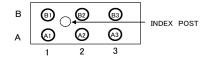


Fig.-1 BLOCK DIAGRAM

♦ PIN CONFIGURATION



♦ PIN No., PIN NAME

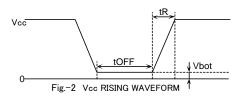
PIN No.	PIN NAME
B3	A2
B2	GND
B1	SDA
A3	VCC
A2	WP
A1	SCL



♦ NOTES FOR POWER SUPPLY

Vcc rises through the low voltage region in which internal circuit of IC and the controller are unstable, so that device may not work properly due to an incomplete reset of internal circuit. To prevent this, the device has the feature of P.O.R. and LVCC. In the case of power up, keep the following conditions to ensure functions of P.O.R. and LVCC.

- 1. It is necessary to be "SDA='H'" and "SCL='L' or 'H'".
- 2. Follow the recommended conditions of tR, tOFF, Vbot for the function of P.O.R. during power up.



♦ RECOMMENDED CONDITIONS OF tR, tOFF, Vbot					
tR	tOFF	Vbot			
Below 10ms	Above 10ms	Below 0.3V			
Below 100ms	Above 10ms	Below 0.2V			

- 3. Prevent SDA and SCL from being "High-Z". In case that condition 1. and/or 2. cannot be met, take following actions.
 - A) Unable to keep condition 1. (SDA is "LOW" during power up.)
 - → Control SDA ,SCL to be "HIGH" as Fig.-3(a), 3(b).
 - B) Unable to keep condition 2.
 - → After power becomes stable, execute software reset.
 - C) Unable to keep both conditions 1 and 2.
 - → Follow the instruction A first, then the instruction B.

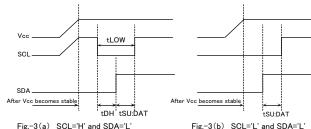


Fig.-3(b) SCL='L' and SDA='L

♦CAUTIONS ON USE

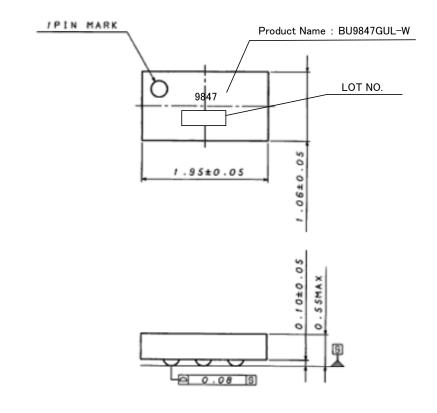
(1) Absolute maximum ratings

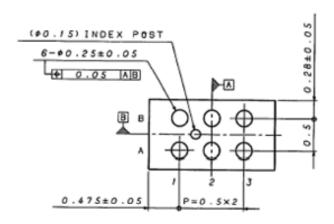
If the absolute maximum ratings such as impressed voltage and action temperature range and so forth are exceeded, LSI may be destructed. Do not impress voltage and temperature exceeding the absolute maximum ratings. In the case of fear exceeding the absolute maximum ratings, take physical safety countermeasures such as fuses, and see to it that conditions exceeding the absolute maximum ratings should not be impressed to LSI.

- (2) GND electric potential
 - Set the voltage of GND terminal lowest at any action condition. Make sure that each terminal voltage is lower than that of GND terminal.
- (3) Thermal design
 - In consideration of permissible loss in actual use condition, carry out heat design with sufficient margin.
- (4) Terminal to terminal shortcircuit and wrong packaging
 - When to package LSI onto a board, pay sufficient attention to LSI direction and displacement. Wrong packaging may destruct LSI. And in the case of shortcircuit between LSI terminals and terminals and power source, terminal and GND owing to foreign matter, LSI may be destructed.
- (5) Use in a strong electromagnetic field may cause malfunction, therefore, evaluated design sufficiently.



♦PHYSICAL DIMENSION





(UNIT:mm)

Drawing No: EX912-5030

Fig-4 PHYSICAL DIMENSION (VCSP50L1) (Unit:mm)

Notes

No copying or reproduction of this document, in part or in whole, is permitted without the consent of ROHM Co.,Ltd.

The content specified herein is subject to change for improvement without notice.

The content specified herein is for the purpose of introducing ROHM's products (hereinafter "Products"). If you wish to use any such Product, please be sure to refer to the specifications, which can be obtained from ROHM upon request.

Examples of application circuits, circuit constants and any other information contained herein illustrate the standard usage and operations of the Products. The peripheral conditions must be taken into account when designing circuits for mass production.

Great care was taken in ensuring the accuracy of the information specified in this document. However, should you incur any damage arising from any inaccuracy or misprint of such information, ROHM shall bear no responsibility for such damage.

The technical information specified herein is intended only to show the typical functions of and examples of application circuits for the Products. ROHM does not grant you, explicitly or implicitly, any license to use or exercise intellectual property or other rights held by ROHM and other parties. ROHM shall bear no responsibility whatsoever for any dispute arising from the use of such technical information.

The Products specified in this document are intended to be used with general-use electronic equipment or devices (such as audio visual equipment, office-automation equipment, communication devices, electronic appliances and amusement devices).

The Products specified in this document are not designed to be radiation tolerant.

While ROHM always makes efforts to enhance the quality and reliability of its Products, a Product may fail or malfunction for a variety of reasons.

Please be sure to implement in your equipment using the Products safety measures to guard against the possibility of physical injury, fire or any other damage caused in the event of the failure of any Product, such as derating, redundancy, fire control and fail-safe designs. ROHM shall bear no responsibility whatsoever for your use of any Product outside of the prescribed scope or not in accordance with the instruction manual.

The Products are not designed or manufactured to be used with any equipment, device or system which requires an extremely high level of reliability the failure or malfunction of which may result in a direct threat to human life or create a risk of human injury (such as a medical instrument, transportation equipment, aerospace machinery, nuclear-reactor controller, fuel-controller or other safety device). ROHM shall bear no responsibility in any way for use of any of the Products for the above special purposes. If a Product is intended to be used for any such special purpose, please contact a ROHM sales representative before purchasing.

If you intend to export or ship overseas any Product or technology specified herein that may be controlled under the Foreign Exchange and the Foreign Trade Law, you will be required to obtain a license or permit under the Law.



Thank you for your accessing to ROHM product informations.

More detail product informations and catalogs are available, please contact us.

ROHM Customer Support System

http://www.rohm.com/contact/